

Maximum Ratings (@ $T_A = +25^{\circ}C$, unless otherwise specified.)

Characte	ristic		Symbol	Value	Unit
Drain-Source Voltage			V _{DSS}	30	V
Gate-Source Voltage			V _{GSS}	±25	V
Continuous Drain Current (Note 5)	Steady State	T _A = +25°C T _A = +85°C	I _D	10 6	А
Pulsed Drain Current (Note 5)			I _{DM}	60	A
Avalanche Current (Notes 6)			I _{AR}	16	А
Repetitive Avalanche Energy (Notes	6) L = 0.1mH		E _{AR}	12.8	mJ

Thermal Characteristics

Characteristic	Symbol	Value	Unit
Power Dissipation (Note 5)	P_{D}	1.42	W
Thermal Resistance, Junction to Ambient @TA = +25°C (Note 5)	$R_{ heta JA}$	88.4	°C/W
Operating and Storage Temperature Range	T_J, T_{STG}	-55 to +150	°C

Electrical Characteristics (@T_A = +25°C, unless otherwise specified.)

Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition	
OFF CHARACTERISTICS (Note 7)							
Drain-Source Breakdown Voltage	BV_{DSS}	30	_	_	V	$V_{GS} = 0V, I_D = 250\mu A$	
Zero Gate Voltage Drain Current	I _{DSS}	1	_	1	μΑ	V_{DS} = 30V, V_{GS} = 0V	
Gate-Source Leakage	I _{GSS}	_	_	±100	nA	$V_{GS} = \pm 25V, V_{DS} = 0V$	
ON CHARACTERISTICS (Note 7)							
Gate Threshold Voltage	V _{GS(th)}	1.0	1.45	2.4	V	$V_{DS} = V_{GS}$, $I_D = 250\mu A$	
Static Drain-Source On-Resistance	D	_	15 25	23 33	mΩ	V _{GS} = 10V, I _D = 10A	
Static Dialii-Source Off-Resistance	R _{DS (ON)}					V _{GS} = 4.5V, I _D = 7.5A	
Forward Transfer Admittance	Y _{fs}	_	2.5	_	S	V _{DS} = 5V, I _D = 10A	
Diode Forward Voltage	V _{SD}	_	0.69	1	V	$V_{GS} = 0V$, $I_S = 1A$	
DYNAMIC CHARACTERISTICS (Note 8)						•	
Input Capacitance	C _{iss}	1	478.9	_	pF		
Output Capacitance	Coss		96.7	_	pF	$V_{DS} = 15V, V_{GS} = 0V,$ f = 1.0MHz	
Reverse Transfer Capacitance	C _{rss}	_	61.4	_	pF	1 - 1.000112	
Gate Resistance	Rg	0.4	1.1	1.6	Ω	$V_{DS} = 0V$, $V_{GS} = 0V$, $f = 1MHz$	
Total Gate Charge (V _{GS} = 4.5V)	Qg	_	5.0	8	nC	V - 15V V - 10V I - 10A	
Total Gate Charge (V _{GS} = 10V)	Qg	_	10.5	17	IIC		
Gate-Source Charge	Q _{gs}	_	1.8	_	nC		
Gate-Drain Charge	Q _{gd}	_	1.6	_	nC		
Turn-On Delay Time	t _{D(on)}	_	2.9	_	ns	$V_{GS} = 10V, V_{DS} = 15V,$ $R_{G} = 3\Omega, R_{L} = 1.5\Omega$	
Turn-On Rise Time	tr		7.9	_	ns		
Turn-Off Delay Time	t _{D(off)}	_	14.6	_	ns		
Turn-Off Fall Time	t _f	_	3.1		ns		

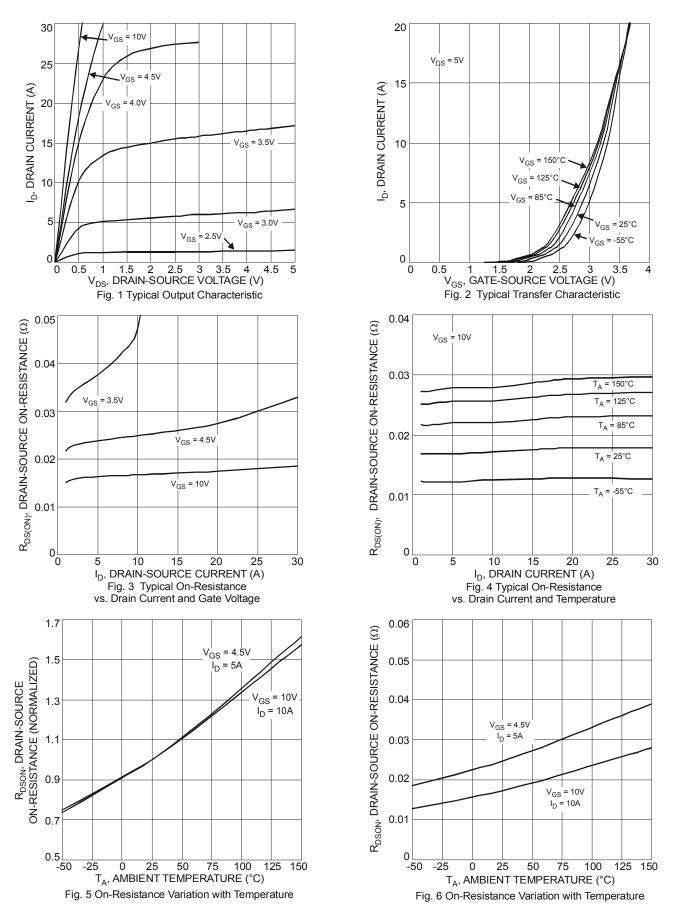
Notes: 5. Device mounted on FR-4 substrate PC board, 2oz copper, with minimum recommended pad layout.

6. I_{AR} and E_{AR} rating are based on low frequency and duty cycles to keep T_J = +25°C

7. Short duration pulse test used to minimize self-heating effect.

8. Guaranteed by design. Not subject to product testing.







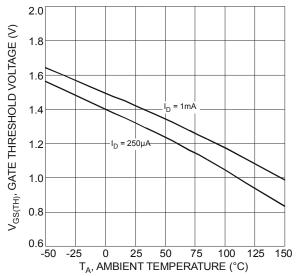
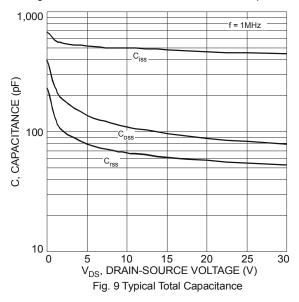
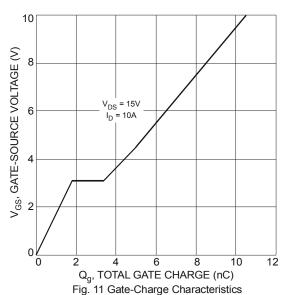
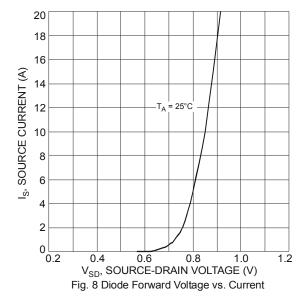
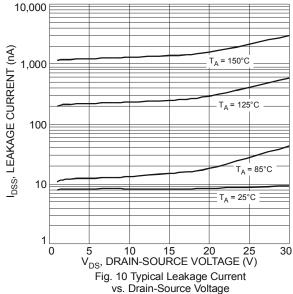


Fig. 7 Gate Threshold Variation vs. Ambient Temperature

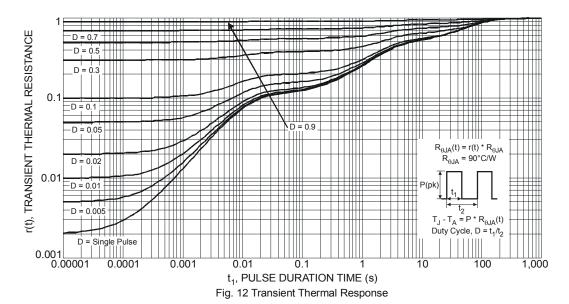






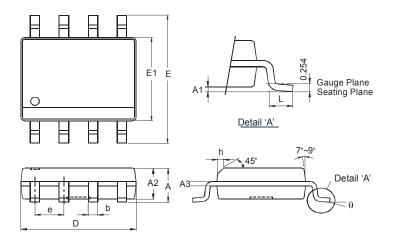






Package Outline Dimensions

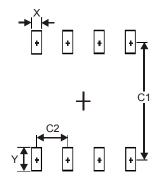
Please see AP02002 at http://www.diodes.com/datasheets/ap02002.pdf for latest version.



SO-8				
Dim	Min	Max		
Α	-	1.75		
A1	0.10	0.20		
A2	1.30	1.50		
A3	0.15	0.25		
b	0.3	0.5		
D	4.85	4.95		
Е	5.90	6.10		
E1	3.85	3.95		
е	1.27 Typ			
h	-	0.35		
١	0.62	0.82		
θ	0°	8°		
All Dimensions in mm				

Suggested Pad Layout

Please see AP02001 at http://www.diodes.com/datasheets/ap02001.pdf for latest version.



Dimensions	Value (in mm)
Х	0.60
Υ	1.55
C1	5.4
C2	1.27



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